504514407 08/22/2017

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2 EPAS ID: PAT4561112

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
MING ZHOU	08/07/2017

RECEIVING PARTY DATA

Name:	SEMICONDUCTOR MANUFACTURING INTERNATIONAL (BEIJING) CORPORATION		
Street Address:	18 WENCHANG ROAD		
Internal Address:	BEIJING ECONOMIC-TECHNOLOGICAL DEVELOPMENT AREA, DAXING DISTRICT		
City:	BEIJING		
State/Country:	CHINA		
Postal Code:	100176		
Name:	SEMICONDUCTOR MANUFACTURING INTERNATIONAL (SHANGHAI) CORPORATION		
Name: Street Address:	·		
-	CORPORATION		
Street Address:	CORPORATION 18 ZHANGJIANG ROAD		
Street Address: Internal Address:	CORPORATION 18 ZHANGJIANG ROAD PUDONG NEW AREA		

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	15683029

CORRESPONDENCE DATA

Fax Number: (312)321-4299

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

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PATENT REEL: 043358 FRAME: 0257 504514407

ATTORNEY DOCKET NUMBER: 15741-6(2016-00055-SH-US)		
NAME OF SUBMITTER: GANG CHEN, REG. NO. 68,754		
SIGNATURE: /Gang Chen/		
DATE SIGNED:	08/22/2017	
Total Attachments: 2		

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> PATENT REEL: 043358 FRAME: 0258

Case No. 15741-6 (2016-00055-SH-US)

ASSIGNMENT

WHEREAS, **MING ZHOU**, the "Assignor", has made the invention described in the United States patent application entitled **SEMICONDUCTOR DEVICE AND MANUFACTURING METHOD THEREFOR**, executed by Assignor on the same date as, or on a date prior to, this Assignment;

WHEREAS, and Semiconductor Manufacturing International (Beijing) Corporation, a corporation organized and existing under the laws of the Country of China, having a place of business at 18 Wenchang Road, Beijing Economic-Technological Development Area, Beijing 100176, China and Semiconductor Manufacturing International (Shanghai) Corporation, a corporation organized and existing under the laws of the Country of China, having a place of business at 18 Zhangjiang Road, Pudong New Area, Shanghai 201203, China, hereinafter the "Assignee", desires to acquire the entire right, title and interest in the invention and the patent application identified above, and all patents which may be obtained for the invention, as set forth below;

NOW, THEREFORE, in consideration of valuable and legally sufficient consideration, the receipt of which by the Assignor from the Assignee is acknowledged, the Assignor has sold, assigned and transferred, and by these presents sells, assigns and transfers to the Assignee, the entire right, title and interest for the United States in the invention and the patent application identified above, and any patents that may issue for the invention in the United States; with the entire right, title and interest in the invention and all patent applications and patents issuing therefrom in all countries foreign to the United States, including the full right to claim for any such application all benefits and priority rights under any applicable convention; with the entire right, title and interest in all continuations, divisions, renewals and extensions of any of the patent applications and patents defined above; with the right to recover all damages, including, but not limited to, a reasonable royalty, by reason of past, present, or future infringement or any other violation of patent or patent application rights; to have hold for

PATENT REEL: 043358 FRAME: 0259 the sole and exclusive use and benefit of the Assignee, its successors and assigns, to the full end of the term or terms for all such patents.

The Assignor covenants and agrees, for both the Assignor and the Assignor's legal representatives, that the Assignor will assist the Assignee in the prosecution of the patent application identified above; in the making and prosecution of any other patent applications that the Assignee may elect to make covering the invention identified above; in vesting in the Assignee like exclusive title in all such other patent applications and patents; and that the Assignor will execute and deliver to the Assignee any and all additional papers which may be requested by the Assignee to carry out the terms of this Assignment.

The Commissioner of Patents and Trademarks is authorized and requested to issue patents to the Assignee under the terms of this Assignment.

IN TESTIMONY WHEREOF, the Assignor has executed this agreement.

DATED:	2017.8.7	mmg zHou	
	7	MING ZHOÚ	

RECORDED: 08/22/2017